

SANYO Semiconductors

DATA SHEET

An ON Semiconductor Company

Bi-CMOS LSI LV5725JA — **Step-down Switching Regulator**

Overview

The LV5725JA is a step-down voltage switching regulator.

Functions

- Wide input dynamic range: 4.5V to 50V.
- Built-in pulse-by-pulse OCP circuit: detection is on resistance of an external MOS.
- Over current protection: HICCUP mode.
- · Load-independent soft start circuit
- Synchronous operation by external signal.
- External voltage is usable when output voltage is high.

Specifications

Absolute Maximum Ratings at Ta = 25°C

- Current mode type.
- Thermal shutdown.
- ON/OFF pin
- Power good pin

Parameter		Parameter Symbol Conditions		Ratings	Unit
Supply voltage		V _{IN} max		55	V
Allowable pin voltage	V _{IN} , SW, OUT, PGOOD			55	V
	HDRV, CBOOT			61	V
	LDRV			6.0	V
	Between CBOOT to SW Between CBOOT to HDRV			6.0	V
	EN, ILIM			V _{IN} +0.3	V
	Between VIN to ILIM			1.0	V
	V _{DD}			6.0	V
	SS, FB, COMP,RT, SYNC			V _{DD} +0.3	V
Allowable Power dissipation		Pd max	Mounted on a specified board. *	1.45	W
Operating temperature		Topr		-40 to +85	°C
Storage temperature		Tstg		-55 to +150	°C

- Any and all SANYO Semiconductor Co.,Ltd. products described or contained herein are, with regard to "standard application", intended for the use as general electronics equipment. The products mentioned herein shall not be intended for use for any "special application" (medical equipment whose purpose is to sustain life, aerospace instrument, nuclear control device, burning appliances, transportation machine, traffic signal system, safety equipment etc.) that shall require extremely high level of reliability and can directly threaten human lives in case of failure or malfunction of the product or may cause harm to human bodies, nor shall they grant any guarantee thereof. If you should intend to use our products for new introduction or other application different from current conditions on the usage of automotive device, communication device, office equipment, industrial equipment etc., please consult with us about usage condition (temperature, operation time etc.) prior to the intended use. If there is no consultation or inquiry before the intended use, our customer shall be solely responsible for the use.
- Specifications of any and all SANYO Semiconductor Co.,Ltd. products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.

Parameter	Symbol	Conditions	Ratings	Unit
Maximum junction temperature	Tj max		150	°C

* Specified board : 58.0mm × 78.0mm × 1.6mm, fiberglass epoxy printed board.

Caution 1) Absolute maximum ratings represent the value which cannot be exceeded for any length of time.

Caution 2) Even when the device is used within the range of absolute maximum ratings, as a result of continuous usage under high temperature, high current, high voltage, or drastic temperature change, the reliability of the IC may be degraded. Please contact us for the further details

high voltage, or drastic temperature change, the reliability of the IC may be degraded. Please contact us for the further details.

Recommended Operating Range at Ta = 25°C

Parameter	Symbol	Conditions	Ratings	Unit
Supply voltage range	V _{IN}		4.5 to 50	V
Error amplifier input voltage	V _{FB}		0 to 1.6	V
Oscillatory frequency	FOSC		50 to 500	kHz

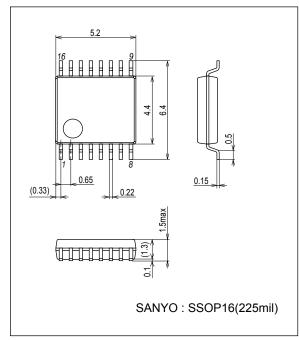
Electrical Characteristics at $Ta = 25^{\circ}C$, $V_{IN} = 12V$

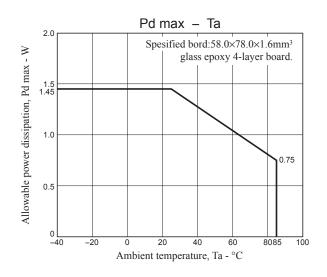
Parameter	Symbol	Conditions		Ratings		Unit
Falancici	Symbol	Conditions	min	typ	max	Unit
Reference voltage block						
Internal reference voltage	Vref	Including offset of E/A	0.698	0.708	0.718	V
5V power supply	V _{DD}	I _{OUT} = 0 to 5mA	4.7	5.2	5.7	V
Triangular waveform oscillator block						
Oscillation frequency	FOSC	RT= 56kΩ	317	365	412	kHz
Frequency variation	FOSC DV	V _{IN} = 4.5 to 50V		1		%
Fold back detection voltage	VOSC FB	After power is supplied to SS, voltage is detected FB.		0.5		V
Fold back oscillation frequency	FOSC FB	RT= 56k Ω , V _{FB} = 0V	100	130	160	kHz
ON/OFF circuit block						
IC start-up voltage	V _{EN} on		-	2.5	3.0	V
Hysteresis of startup voltage	V _{EN} hys		0.3	0.6	-	V
Soft start circuit block	•	·				
Soft start source current	I _{SS} SC	EN > 3.0V	4	5	6	μA
Soft start sink current	I _{SS} SK	EN < 1V, V _{DD} = 5V		2		mA
Soft start end voltage	V _{SS} END		0.7	0.9	1.1	V
UVLO circuit block				·		
UVLO voltage	VUVLO		3.7	4.0	4.3	V
Hysteresis of UVLO	VUVLO H			0.3		V
Error amplifier						
Input bias current	IEA IN				100	nA
Error amplifier gain	G _{EA}		1000	1400	1800	μA/V
Range of common-mode input voltage	V _{EA R}	V _{IN} = 4.5 to 50V	0		1.6	V
Output sink current	IEA OSK	FB = 1.0V		-100		μA
Output source current	IEA OSC	FB = 0V		100		μA
Current detection amplifier gain	GISNS			2.4		
Over current limiter circuit block						
Reference current	ILIM		-10%	20	+10%	μA
Over current detection comparator offset voltage	V _{LIM_OFS}		-5		+5	mV
Range of over current detection comparator common mode input	V _{LIM_CM}		V _{IN} -0.45		V _{IN}	V
PWM comparator			· ·			
Input threshold voltage	Vt max	Duty cycle = D _{MAX} , SW = V _{IN}	1.15	1.25	1.35	V
	Vt0	Duty cycle = 0%, SW = V _{IN}	0.5	0.6	0.7	V
Maximum ON duty	D _{MAX}		92			%

Description	0 stat		Ratings				
Parameter	Symbol Conditions		min	typ	max	Unit	
Power good							
Power good "L" sink current	IPGL	PGOOD = 5V		5		mA	
Power good "H" sink current	I _{PG} H	PGOOD = 5V			1	μA	
Power good voltage	PG _{thresh}	When FB voltage rises		0.612		V	
Hysteresis of power good	PG _{hys}			12		mV	
Output block	• -	·	· · ·				
High side output ON resistance (upper)	R _{ONH} _HIGH	CBOOT – HDRV = -0.1V		12		Ω	
High side output ON resistance (lower)	R _{ONL} _HIGH	HDRV – SW = +0.1V		3.3		Ω	
Low side output ON resistance (upper)	R _{ONH} LOW	$V_{DD} - LDRV = -0.1V$		7.9		Ω	
Low side output ON resistance (lower)	R _{ONL} LOW	LDRV – GND = +0.1V		3.8		Ω	
High side output ON current (upper)	I _{ONH_} HIGH	CBOOT – HDRV = -4.5V	160			mA	
High side output ON current (lower)	I _{ONL_} HIGH	HDRV – SW = +4.5V	330			mA	
Low side output ON current (upper)	I _{ONH_} LOW	V _{DD} – LDRV = -5.2V	190			mA	
Low side output ON current (lower)	I _{ONL_} LOW	LDRV – GND = +5.2V	250			mA	
Entire device	•	•	·				
Standby current	ICCS	EN < 1V			1	μA	
Average current consumption	ICCA	EN > 3.0V		2.5		mA	

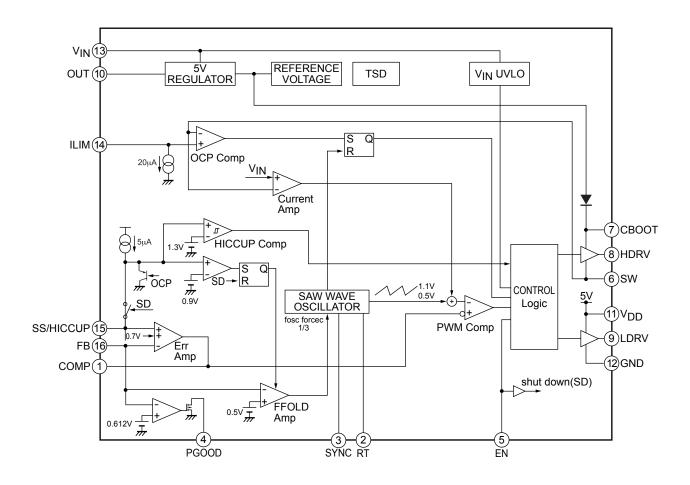
Package Dimensions

unit : mm (typ) 3178B

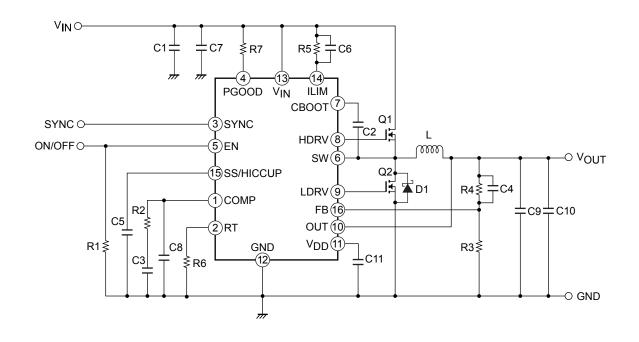




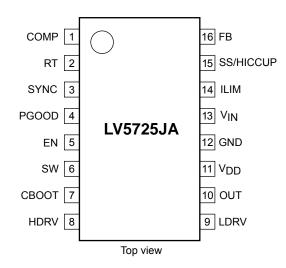
Block Diagram



Sample application circuit



Pin Assignment



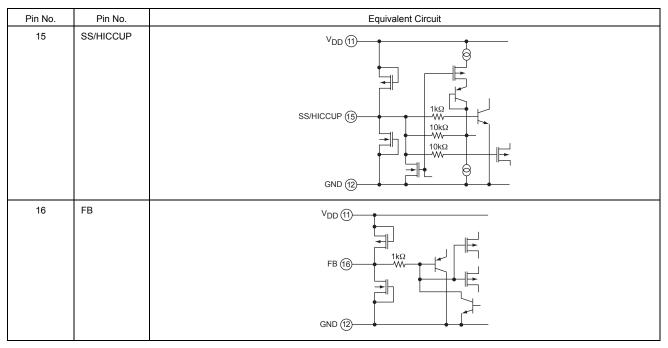
Pin Function

Pin No.	Pin name	Description
1	COMP	Error amplifier output pin. Make sure to connect a phase compensation network between COMP and GND.
2	RT	Oscillating frequency setting pin. Make sure to connect a resistor between this pin and GND.
3	SYNC	External synchronous signal input pin.
4	PGOOD	Power good pin.
5	EN	ON/OFF pin.
6	SW	This pin is connected to switching node. Connect the source of Nch MOSFET to this pin.
7	СВООТ	Bootstrap capacitor connected pin. This pin is used as gate driving power supply for external Nch MOSFET. Make sure to connect a capacitor between CBOOT and SW.
8	HDRV	External upper MOSFET gate driving pin.
9	LDRV	External lower MOSFET gate driving pin.
10	OUT	Internal regulator power supply pin. This pin is connected to VOUT.
11	V _{DD}	Power supply pin for gate drive of the external lower MOS-FET.
12	GND	Ground pin. GND pin voltage is the reference for each reference voltage.
13	VIN	Power supply pin. This pin is monitored by UVLO function. When the voltage of this pin becomes higher than 4.3V by UVLO function, the IC starts up and mode shifts to soft start operation.
14	ILIM	Reference current pin for current detection. The inlet current of approx. 20µA flows into this pin. Connect a resistor externally between this pin and VIN and when the voltage supplied to SW pin is lower than the pin voltage of this resistor, the upper Nch MOSFET is turned off by current limiter comparator. This operation is reset at every PWM pulse.
15	SS/HICCUP	Capacitor connection pin for soft start. This pin enables to charge the soft start capacitor by 5µA. (approx) When this pin turns approx. 0.9V, soft start period ends and frequency fold back function is activated.
16	FB	Error amplifier reverse input pin. Converter operates to set this pin to 0.708V. The output voltage divided by the external resistance is applied to this pin. After soft start, frequency fold back function operates when the voltage of this pin becomes 0.5V or lower. And oscillating frequency decreases together with FB voltage.

I/O pin equivalent circuit chart

Pin No.	Pin No.	Equivalent Circuit	
1	СОМР	$V_{DD} (1)$ $COMP (1$	
2	RT	VDD (1) $10k\Omega$ T T T T T T T T	
3	SYNC	V _{DD} (1) SYNC (3) GND (2) VDD (1) SYNC (3) SYNC (
4	PGOOD	VDD (1) PGOOD (4) GND (12)	
5	EN	$V_{DD} (1) $ $EN (5) $ $462k\Omega 365k\Omega $ $650k\Omega $	
6	SW	CBOOT \overline{O} VIN \overline{O} SW \overline{O} GND \overline{O}	

Pin No.	Pin No.	Equivalent Circuit
7	CBOOT	$V_{DD} (1) \longrightarrow W_{D}$ $CBOOT (7) \longrightarrow W_{10\Omega}$ $V_{IN} (13) \longrightarrow W_{10\Omega}$ $V_{IN} (13) \longrightarrow W_{10\Omega}$ $SW (6) \longrightarrow W_{10}$
8	LDRV	CBOOT (7) HDRV (8) SW (6) GND (2)
9	HDRV	
10	OUT	
11	V _{DD}	
12, 13	GND, V _{IN}	
14	ILIM	VIN (3) C S S S S ILIM (14) GND (12)



- SANYO Semiconductor Co.,Ltd. assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all SANYO Semiconductor Co.,Ltd. products described or contained herein.
- Regarding monolithic semiconductors, if you should intend to use this IC continuously under high temperature, high current, high voltage, or drastic temperature change, even if it is used within the range of absolute maximum ratings or operating conditions, there is a possibility of decrease reliability. Please contact us for a confirmation.
- SANYO Semiconductor Co.,Ltd. strives to supply high-quality high-reliability products, however, any and all semiconductor products fail or malfunction with some probability. It is possible that these probabilistic failures or malfunction could give rise to accidents or events that could endanger human lives, trouble that could give rise to smoke or fire, or accidents that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.
- In the event that any or all SANYO Semiconductor Co.,Ltd. products described or contained herein are controlled under any of applicable local export control laws and regulations, such products may require the export license from the authorities concerned in accordance with the above law.
- No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written consent of SANYO Semiconductor Co.,Ltd.
- Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. When designing equipment, refer to the "Delivery Specification" for the SANYO Semiconductor Co.,Ltd. product that you intend to use.
- Upon using the technical information or products described herein, neither warranty nor license shall be granted with regard to intellectual property rights or any other rights of SANYO Semiconductor Co.,Ltd. or any third party. SANYO Semiconductor Co.,Ltd. shall not be liable for any claim or suits with regard to a third party's intellectual property rights which has resulted from the use of the technical information and products mentioned above.

This catalog provides information as of May, 2012. Specifications and information herein are subject to change without notice.